# Harvatek Surface Mount CHIP LEDs Approval Sheet **Model No.: HT-155SD/YG**

Acknowledged by

**Section Manager** 

**Production Engineering Dept.** 

Manager

**Production Engineering Dept.** 

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Tentative Product	*******	******	HDS-155-K369	
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### Introduction

- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by HARVATEK for any infringements of intellectual property or other rights of the third parties which may result from its use.
- Harvatek is continually effort to improve the quality of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing HARVATEK products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such HARATEK products cause loss of human life, bodily injury or damage to property.
- The HARVATEK products listed in this document are intended for usage in general electronics (computer, personal equipment, office equipment, industrial robotics, domestic, etc...) These products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction.
- In developing your designs, please ensure that HARVATEK products are used within the specified operating ranges as set forth in the most recent HARVATEK product specifications.
- Also, please keep in mind the precautions stated in this document.

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### **Product Specification**

	Specification	Material	Quantity
lv	SD: J: 4.5–7.2 mcd		
	K: 7.2-11.2 mcd		
	L: 11.2-18 mcd or above		
	YG: L: 11.2-18 mcd		
	M: 18-28.5 mcd or above		
	@20mA/ Ta= 25° C Tolerance±10%		
Lambda ( λ <sub>D)</sub>	SD: 615-635 nm		
	YG: 570.5-576.5 nm		
	@20mA/ Ta= 25° C Tolerance±0.5nm		
Vf	1.6-2.4V		
	@20mA/ Ta= 25° C Tolerance±0.05V		
Ir	HT standard		
Resin	Milky Diffused	Epoxy resin	
Carrier tape	According to EIA 481-1A specs	Transparent tape	3000pcs per reel
Reel	According to EIA 481-1A specs	Plastic/ White	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/	One reel one bag
		no-zipper	
Carton	HT standard	Paper	Non-specified

#### Others:

Every small-box will be loaded 5 reels. These 5 reels can be different in lot, lv, lambda, or Vf. Every reel will have an independent label to identify its specification and the small-box there will have a corresponding label post on it.

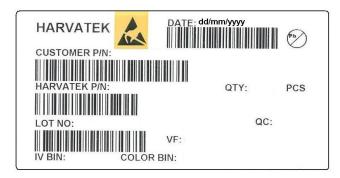


ESD protection for GaP and AlGaAs chips are still necessary even though they are safety in low static-electric discharge. Material in AlInGaP, GaN, or/and InGaN chips are **STATIC SENSITIVE device**. ESD protection shall be considered and taken in the initial design stage.

If manual work/process is needed, please ensure the device is well protective from ESD within all the process.

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### Label Spec.:



■ Customer P/N: To Be Defined

■ Harvatek P/N

# H T - 1 5 5 SD/YG

Series Name Emitting Color

SD:
Super Bright Orange
YG
Yellow Green

Lot No.

1 2 3 4 5 6 7 8 9 10 11

# P 1 2 2 3 0 A - D T J/L

Code 1	Code 2	Code 3	Code 4, 5	Code 6, 7	Code 9	Code 10	Coc	le 11
	Mfg. Year	Mfg. Month	Mfg. Date	Mfg. Date Lots		Packing type	Brigh	ntness
	Ū				Color	<b>5</b> 7.	SD	YG
Internal Tracing Code	Z: 2000 1: 2001	1: Jan. 2: Feb A: Oct. B: Nov. C: Dec.	1~31/ (30)	01~99,	D: Milky White	T: For Taped Reel	K:7.2-11.2 L:11.1-18	L:11.2-18 M:18-28.5 mcd or above

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### **Product Feature**

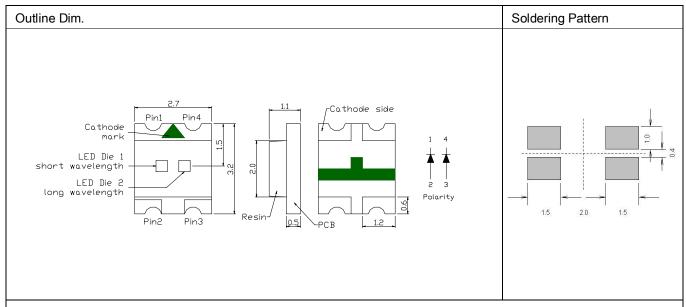
### **Electro-Optical Characteristics**

(I<sub>F</sub> @ 20mAT<sub>a</sub> 25°C)

Code for parts	Lighting Color Mater		V <sub>F</sub> (\	<b>V</b> )		λ(nm)		I*v(	mcd)
Code for parts	Lighting Color	Material	typ	max	$\lambda_{D}$	$\lambda_{P}$	Δλ	min	typ
HT-155SD/YG	Super Bright Orange (SD)	GaAsP	2.1	2.6	629	642	35	5.6	14
	Yellow Green (YG)	GaP	2.2	2.6	573	568	30	9	20

## Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering

Unit: mm Tolerance: +/-0.1



- 1. Soldering terminal may shift in x, y direction.
- 2. LED die 1 and LED die 2 can be the same chips.
- 3. Both dices in the package need to be either P side-up or N side-up.

### **Absolute Maximum Ratings**

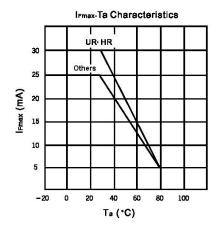
(Ta 25 °C)

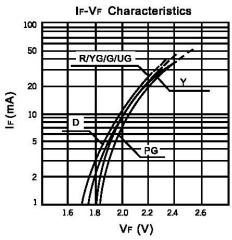
Series	P <sub>d</sub> (mW)	I <sub>F</sub> (mA)	I <sub>FP</sub> (mA)	V <sub>R</sub> (V)	T <sub>OP</sub> (°C)	T <sub>ST</sub> (°C)
SD	65	25	100**	5	-30~+80	-40~+85
YG	65	25	100**	5	-30~+80	-40~+85

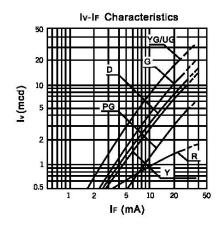
<sup>\*\*</sup> Condition for  $I_{FP}$  is pulse of 1/10 duty and 0.1msec widt

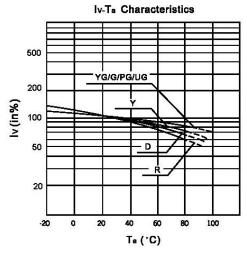
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### **Characteristics of HT-155 Series**





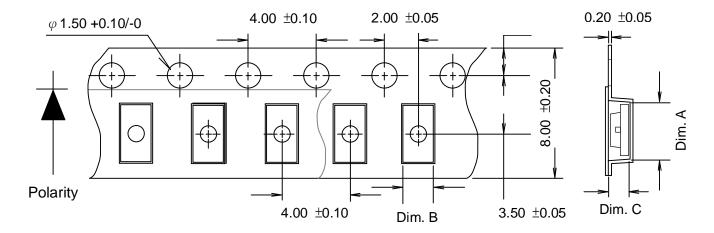




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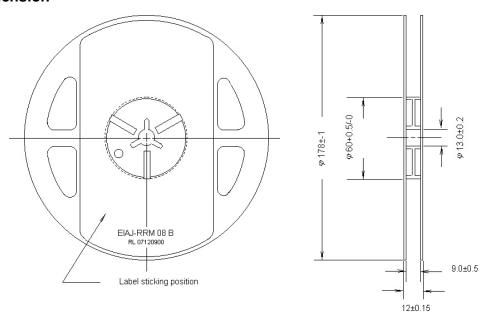


# Packaging Tape, Reel, and Packing Model Tape Dimension



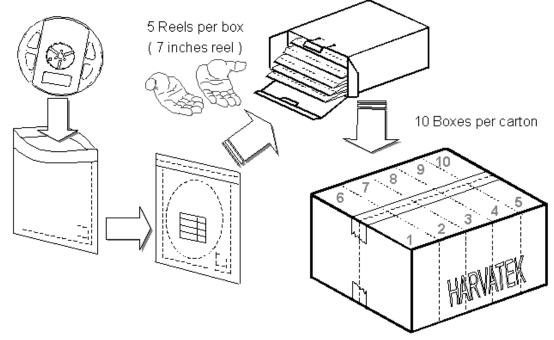
Part No.	Dim. A	Dim. B	Dim. C	Q'ty/Reel
HT-155	3.52±0.10	3.02±0.10	1.40±0.10	3K

### **Reel Dimension**



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### **Packing Model**



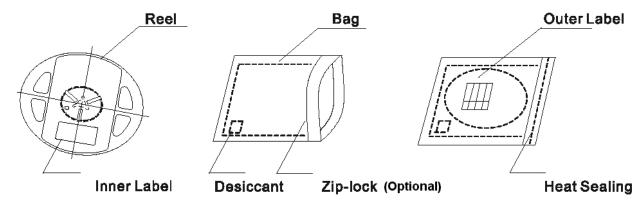
5 boxes per carton is available according to shipping quantity.

### **Dry Pack**

Any SMD optical device, like this chip LED, is **MOISTURE SENSITIVE device**. Avoid absorbing moisture at any time during transportation or storage. Every reel will be packaged in the moisture barrier anti-static bag (Specific bag material will depend upon customers' requirement or option). And the bag is well sealed before shipment.

By customer's requirement, we will put a humidity indicator in each moisture barrier anti-static bag before shipment.

The package is the following:



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### **Storage**

It's recommended to store the products in the following conditions:

Humidity: 60 %RH Max.

Temperature: 5 °C ~30 °C (41°F~86 °F)

- 1 Shelf life in sealed bag: 12 month at<40 <sup>O</sup>C and <90%RH. (Base on aluminum laminated moisture barrier bag.)
- 2 After the bag is opened, devices that will be subjected to infrared reflow, vapor-phase reflow, or equivalent processing must be:
  - 2.1 Mounted within 72 hours at factory conditions of  $\leq 30$  °C /60% RH, or
  - 2.2 Stored at  $\leq$  20% RH with zip-lock sealed.

### **Baking**

It's recommended to bake before soldering once the pack is unsealed open & re-sealed after 72 hours. The conditions are as followings:

 $60 \pm 3^{\circ}$ C×(12~24hrs) and < 5% RH, taped reel type

100±3°Cx(45min~1hr), bulk type

 $130\pm3^{\circ}C\times(15\sim30\text{min})$ , bulk type

### **Soldering**

Manual soldering (We do not recommend this method strongly.)

Soldering wire: 63/37 Sn/Pb, flux contained.

To prevent cracking, please bake before manual soldering, if the device is subject to moisture.

Temperature at tip of soldering tool : 300 °C±5 °C Max.(25W)

It's banned to load any stress on the resin during soldering.

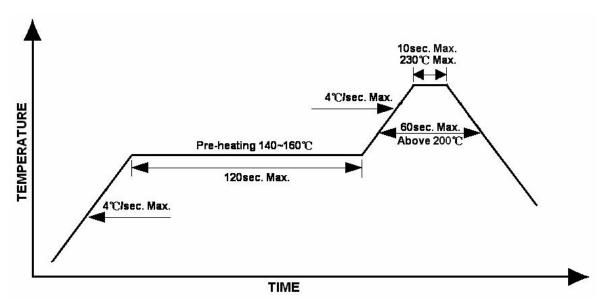
Soldering time: 3±1sec

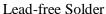
## Reflow Soldering

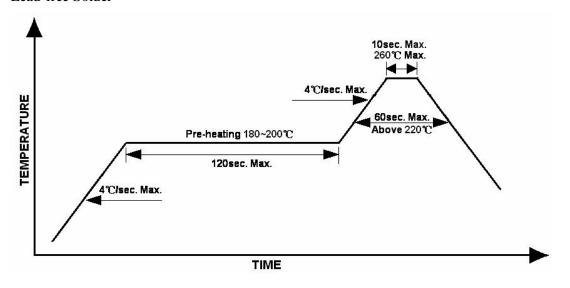
- Recommend tin glue specifications:
   Melting temperature: 178~192 °C
- Never take next process until the component is cooled down to room temperature after reflow.
- ◆ The recommended reflow soldering profile (measuring on the surface of the LED resin) is following:

Lead Solder

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### Cleaning

The conditions of cleaning after soldering:

An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.

Temperature×Time: <50 °C×30sec, or <30 °C×3min

Ultra sonic cleaning: < 15W/ bath; Bath volume: 1liter max.

Curing: 100 °C max, <3min

Do not contact with component on the assembly board.

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### **Cautions of Pick and Place**

It should be avoided to load stress on the resin during high temperature.

Avoid rubbing or scraping the resin by any object.

Electric-static may cause damage to the component. Please confirm that the equipment grounding well. Using an ionizer fan is recommended.

### **Reliability Test**

Item	Frequency/ lots/ samples/ failures	Standards Reference	Conditions
Precondition	For all reliability monitoring tests according to JEDEC Level 2	J-STD-020	1.) Baking at 85°C for 24hrs 2.) Moisture storage at 85°C/ 60% R.H. for 168hrs
Solderability	1Q/ 1/ 22/ 0	JESD22-B102-B And CNS-5068	Accelerated aging 155°C/ 24hrs Tinning speed: 2.5±0.5cm/s Tinning: A: 215°C/ 3±1s or B: 260°C/ 10±1s
Resistance to Soldering heat	1/100/0	JESD22-A113	3x IR-reflow-soldering according to soldering profile
Operating life test	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs 85°C/ 60%R.H. for 168hrs 2.) T <sub>amb</sub> 25°C; I <sub>F</sub> =20mA; duration 1000hrs
High humidity, high temperature bias	1Q/ 1/ 45/ 0	JESD-A101-B	T <sub>amb</sub> : 85°C Humidity: 85% R.H., I <sub>F</sub> =5mA Duration: 1000hrs
High temperature bias	1Q/ 1/ 20	HT specs.	T <sub>amb</sub> : 55°C I <sub>F</sub> =20mA Duration: 1000hrs
Pulse life test	1Q/ 1/ 40/ 0		$T_{amb}25^{\circ}C$ , $I_f$ =20mA,, $I_p$ =100mA, Duty cycle=0.125 (tp=125 $\mu$ s,T=1sec) Duration 500hrs)
Temperature cycle	1Q/ 1/ 76/ 0	JESD-A104-A IEC 68-2-14, Nb	A cycle: -40 degree C 15min; +85 degree C 15min Thermal steady within 5 min 300 cycles 2 chamber/ Air-to-air type
High humidity storage test	1Q/ 1/ 40/ 0	CNS-6117	60±3°C 90+5/-10% R.H. for 500hrs
High temperature storage test	1Q/ 1/ 40/ 0	CNS-554	100 <u>+</u> 10°C for 500hrs
Low temperature storage test	1Q/ 1/ 40/ 0	CNS-6118	-40 <u>+</u> 5°C for 500hrs

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